# PATENT ASSIGNMENT COVER SHEET

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SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT

### **CONVEYING PARTY DATA**

Name	Execution Date
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Shih-Hung Tsai	11/05/2014
Ssu-I Fu	11/05/2014
Chih-Sen Huang	11/05/2014
Li-Wei Feng	11/05/2014
Jyh-Shyang Jenq	11/05/2014

## RECEIVING PARTY DATA

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### **PROPERTY NUMBERS Total: 1**

Property Type	Number
Application Number:	14539225

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NAME OF SUBMITTER:	ANNA SHILLINGBURG
SIGNATURE:	/Anna Shillingburg/
DATE SIGNED:	11/12/2014
	This document serves as an Oath/Declaration (37 CFR 1.63).

**Total Attachments: 4** 

PATENT REEL: 034155 FRAME: 0533

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Serial No.
Attorney Docket No.
Ref. No. UMCD-2014-0343
Sundial Ref. No. LIS10987PA

## Combined Declaration and Assignment for Patent Application

For the subject matter which is claimed and for which a patent is sought on the invention entitled:

IANUFACTURING ME	THOD OF A SEMICONDUCTOR STRUCTURE
ereby declare that: As a below i	named inventor
The specification of which is	attached hereto unless the following box is checked
was filed on	
as United States Application	Number or PCT International Application Number

## ASSIGNMENT

WHEREAS, I(we), the named inventor(s), whose post office address(es) appear(s) below, hereinafter referred to as Assienor.

#### WHEREAS, United Microelectronics Corp.

or/and imprisonment of not more than five (5) years.

whose post office address is No3, Li-Hsin Rd.II, Hsinchu Science Park, Taiwan 30078, ROC.

hereinafter referred to as Assignee, is desirous of acquiring the entire right, title and interest in and to the same in the United States and its territorial possessions.

NOW, THEREFORE, for good and valuable consideration, receipt of which is hereby acknowledged, I (we), ASSIGNOR, by these presents do sell, assign and transfer unto said ASSIGNEE, the entire right, title, and interest in and to said INVENTION and application throughout the United States of America, including any and all Letters Patent granted on any division, continuation, continuation-in-part, and reissue of said application for the full term or terms for which the same may be granted, including all priority rights under any International Convention.

ASSIGNOR further covenants that no assignments, sale, agreement or encumbrance has been or will be made or entered into which would conflict with this Assignment.

ALSO, Assignor hereby agrees to execute any documents that legally may be required in connection with the filing, prosecution and maintenance of said application or any other patent application(s) in the United States for said

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Serial No.	
Attorney Docket	No
Ref. No. UMCD-	
Sundial Ref. No.	US10987PA

Invention, including additional documents that may be required to affirm the rights of Assignes in and to said Invention, all without further consideration. Assignor also agrees, without further consideration and at Assignes's expense, to identify and communicate to Assignes at Assignes's request documents and information concerning the Invention that are within Assignor's possession or control, and to provide further assurances and testimony on behalf of Assignes that lawfully may be required of Assignor in respect of the prosecution, maintenance, litigation and defense of any patent application or patent encompassed within the terms of this instrument. Assignor's obligations under this instrument shall extend to Assignor's heirs, executors, administrators and other legal representatives;

ALSC, Assignor hereby authorizes and requests the Commissioner of Patents and Trademarks to issue any and all Letters Patent referred to above to Assignee, as the Assignee of the entire right, title and interest in and to the same, for Assignee's sole use and behoof; and for the use and behoof of Assignee's legal representatives and successors, to the full end of the term for which such Letters Patent may be granted, as fully and entirely as the same would have been held by Assigner had this assignment and sale not been made.

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Serial No.\_\_\_\_\_ Attorney Docket No.\_\_\_\_ Ref. No. UMCD-2014-0343 Sundial Ref. No. US10987PA

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Serial No. Attorney Docket No. Ref. No. UMCD-2014-0343 Sundial Ref. No. US10987PA

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